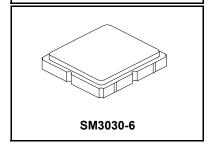


AEC-Q200
RoHS Compliance
This component is compliant with RoHS directive.
This component was always
RoHS compliant from the first date of manufacture.

SF2375E

1538.5 MHz SAW Filter



RF Filter for Mobile Communication Applications

- Low Insertion Loss
- 3.0 x 3.0 x 1.3 mm Surface-Mount Case
- No Matching Circuit Required

Absolute Maximum Ratings

| Rating | Value | Units | |
|--|-----------------|-------|--|
| Maximum Incident Power in Passband | +10 | dBm | |
| Maximum DC Voltage Between any 2 Terminals | 3 | VDC | |
| Storage Temperature Range | -40 to +85 | °C | |
| Operating Temperature | -40 to +85 | °C | |
| Maximum Soldering Profile | 265 °C for 10 s | | |

| Characteristic | Sym | Notes | Min | Тур | Max | Units |
|--|----------------|---------|-----|--------|-----|--------|
| Center Frequency | f _C | 1 | | 1538.5 | | MHz |
| Insertion Loss, 1518 to 1559 MHz | IL | | | 3.4 | 3.8 | dB |
| Amplitude Ripple, 1518 to 1559 MHz | | | | 0.7 | 1.8 | uБ |
| Attenuation Reference level from 0 dB: | | | | | | dB |
| 80 to 1442 MHz | | 1, 2, 3 | 29 | 48 | | uБ |
| 1636 to 2000 MHz | | | 29 | 45 | | |
| Temperature Coefficient of Frequency | | | | -36 | | Ppm/°C |

| Case Style | SM3030-6 3 x 3 mm Nominal Footprint |
|---|-------------------------------------|
| Lid Symbolization (YY=year, WW=week, D=day) | 6C YWWS |

NOTES:

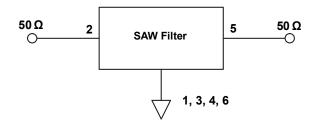
- 1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- 4. "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."

- The design, manufacturing process, and specifications of this filter are subject to change.
- Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 7. US and international patents may apply.
- 8. Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.
- 9. Electrostatic Sensitive Device. Observe precautions for handling.

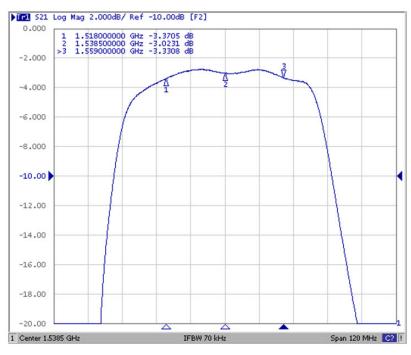


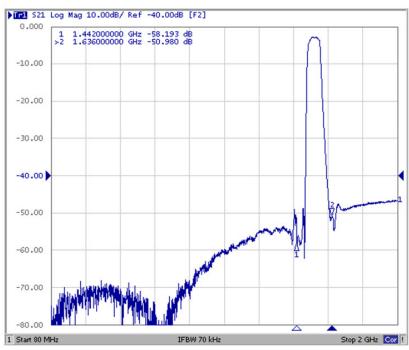
Electrical Connections

| Connection | Terminals |
|------------|------------|
| Input | 2 |
| Output | 5 |
| Ground | All others |



Frequency Characteristics

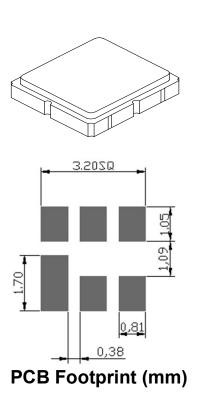




SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint

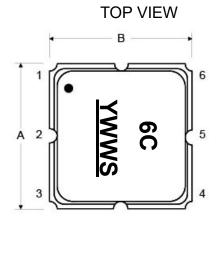
Case and PCB Footprint Dimensions

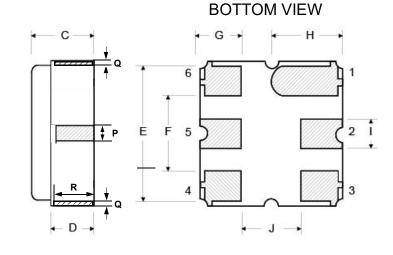


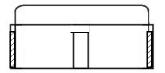
| Dimension | mm | | Inches | | | |
|--------------|------|------|--------|-------|-------|-------|
| Dillielision | Min | Nom | Max | Min | Nom | Max |
| Α | 2.87 | 3.00 | 3.13 | 0.113 | 0.118 | 0.123 |
| В | 2.87 | 3.00 | 3.13 | 0.113 | 0.118 | 0.123 |
| С | 1.12 | 1.25 | 1.38 | 0.044 | 0.049 | 0.054 |
| D | 0.77 | 0.90 | 1.03 | 0.030 | 0.035 | 0.040 |
| E | 2.67 | 2.80 | 2.93 | 0.105 | 0.110 | 0.115 |
| F | 1.47 | 1.60 | 1.73 | 0.058 | 0.063 | 0.068 |
| G | 0.72 | 0.85 | 0.98 | 0.028 | 0.033 | 0.038 |
| Н | 1.37 | 1.50 | 1.63 | 0.054 | 0.059 | 0.064 |
| ı | 0.47 | 0.60 | 0.73 | 0.019 | 0.024 | 0.029 |
| J | 1.17 | 1.30 | 1.43 | 0.046 | 0.051 | 0.056 |
| K | | 3.20 | | | 0.126 | |
| L | | 1.70 | | | 0.067 | |
| M | | 1.05 | | | 0.041 | |
| N | | 0.81 | | | 0.032 | |
| 0 | | 0.38 | | | 0.015 | |
| Р | 0.15 | 0.30 | 0.45 | 0.005 | 0.011 | 0.017 |
| Q | 0.07 | 0.20 | 0.36 | 0.002 | 0.007 | 0.014 |
| R | 0.62 | 0.7 | 0.78 | 0.024 | 0.027 | 0.030 |

Case Materials

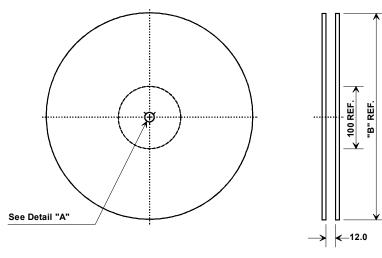
| Materials | | | | |
|-----------------------|--|--|--|--|
| Solder Pad Plating | 0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel | | | |
| Lid Plating | 2.0 to 3.0 µm Nickel | | | |
| Body | Al ₂ O ₃ Ceramic | | | |
| Pb Free | | | | |



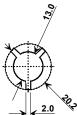




Tape and Reel Specifications



| | 'B" nal Size | Quantity Per Reel |
|--------|-----------------|-------------------|
| Inches | millimeters | |
| 7 | 178 | 500 |
| 13 | 330 | 3000 |



COMPONENT ORIENTATION and DIMENSIONS

| Carrier Tape Dimensions | | | | |
|-------------------------|---------|--|--|--|
| Ao | 3.30 mm | | | |
| Во | 3.30 mm | | | |
| Ко | 1.40 mm | | | |
| Pitch | 4.0 mm | | | |
| W | 12.0 mm | | | |

